

View Online at <https://aerobasegroup.com/nsn/8040-01-624-4033>

**Physical Form:**

Liquid

**Quantity Within Each Unit Package:**

2.000 grams

**Specific Usage Design:**

For circuit board bonding and repair applications

**Rated Drying Time:**

24.000 hours

**Special Features:**

Room temperature or elevated temperature cure; 24 hours at room temperature, 4 hours at 149 degrees f; service temperature range of minus 67 degrees f to plus 275 degrees f

**Color:**

Clear

**Material:**

Plastic epoxy

**Supplementary Features:**

2 gram kit (pre-measured package)

**Shelf Life:**

N/a

**Unit Of Measure:**

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**Demilitarization:**

No

**Fig:**

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